

Samco Shanghai Seminar

INVITATION

Organizer : **Samco Inc. , Kyoto**

Date : **March 13, 2017 13:30 – 17:30**

Place : **Fudan University Yifu Hall**

Participation Fee : **Free**

Main Theme :

“Process Technology and Applications of New Generation SiC Power Devices”

13:30 – 13:40	Opening speech	Osamu Tsuji / Samco Inc. CEO
13:40 – 14:20	Key note speech	“New Materials and Different Field Technologies are Expanding the Semiconductor World” Hidemi Takasu / ROHM Co., Ltd. Colleague (former managing director) Tsinghua University Guest professor
14:20 – 15:00	Lecture 1	“Advances in SiC Epitaxy and Devices” Dr.Feng Zhang / Global Power Technology Co., Ltd. CTO
15:00 – 15:20		Coffee break
15:20 – 15:30	Introduction	“Introduction of Samco” Jianhui Zhou / Samco Inc. Shanghai Office
15:30 – 16:10	Lecture 2	“Application Issues and Packaging for Wide Band Gap Devices” Prof.Xu Yang / Xi’an Jiaotong University
16:10 – 16:50	Lecture 3	“Introduction of Advanced SiC Etching Process and Dry Etching System” Chikashi Oshige / Samco Inc. R&D division
16:50 – 17:30	Lecture 4	“Nanofabrication and its Applications in Basic Scientific Study” Prof.Yifang Chen / Fudan University

Contact: Samco Shanghai Office
Zhou Jianhui
Tel: 021-62494662 Fax: 021-62494663
Mobile: 13621913026 URL: www.samco.co.jp/simp_chinese/
Rm.1410,Shanghai Overseas Chinese Mansion,
129 West Yan'an Road, Shanghai,200040 China